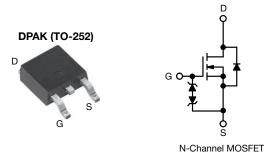
## SiHD5N80AE

**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 1.17			
Q <sub>g</sub> max. (nC)	16.5			
Q <sub>gs</sub> (nC)	3			
Q <sub>gd</sub> (nC)	6			
Configuration	Single			

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy

ORDERING INFORMATION			
Package	DPAK (TO-252)		
Lead (Pb)-free and halogen-free	SiHD5N80AE-GE3		

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	800	V
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain current ( $T_{1} = 150 \text{ °C}$ )	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		4.4	
Continuous drain current $(T_j = 150^{\circ} C)$	VGS AL TO V	T <sub>C</sub> = 100 °C	Ι <sub>D</sub>	2.8	А
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	7		
Linear derating factor			0.5	W/°C	
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	17	mJ	
Maximum power dissipation		PD	62.5	W	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	70		
Reverse diode dv/dt <sup>d</sup>			0.3	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup> For 10 s			260	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>a</sub> = 25  $\Omega$ , I<sub>AS</sub> = 1.1 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C

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HALOGEN

FREE



THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MAX.			UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	62		°044			
Maximum junction-to-case (drain)	R <sub>thJC</sub>		2		°C/W		
SPECIFICATIONS (T <sub>J</sub> = 25 $^{\circ}$ C, u	Inless otherwi	se noted)					
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
		١	/ <sub>GS</sub> = ± 20 V	-	-	± 10	
Gate-source leakage	I <sub>GSS</sub>	١	/ <sub>GS</sub> = ± 30 V	-	-	± 50	μA
		V <sub>DS</sub> =	800 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 640 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.5 A	-	1.17	1.35	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 2 A	-	1.2	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	321	-	-
Output capacitance	C <sub>oss</sub>	۱ ۱	$V_{\rm DS} = 0.0$ V, $V_{\rm DS} = 100$ V,		20	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	4	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{\text{DS}}$ = 0 V to 480 V, $V_{\text{GS}}$ = 0 V		-	14	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	71	-	1
Total gate charge	Qg			-	11	16.5	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2 A, V <sub>DS</sub> = 640 V	-	3	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	6	-	
Turn-on delay time	t <sub>d(on)</sub>			-	12	24	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 640 \; V, \; I_{\text{D}} = 2 \; A, \\ V_{\text{GS}} = 10 \; V, \; R_{\text{g}} = 9.1 \; \Omega \end{array}$		8	16	1
Turn-off delay time	t <sub>d(off)</sub>				10	20	ns
Fall time	t <sub>f</sub>			-	28	56	
Gate input resistance	R <sub>g</sub>	f = 1	MHz, open drain	1.6	3.2	6.4	Ω
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.4	
Pulsed diode forward current	I <sub>SM</sub>			-	-	7	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °0	C, I <sub>S</sub> = 2 A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>			-	267	534	ns
Reverse recovery charge		T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 2 A, di/dt = 100 A/μs, V <sub>B</sub> = 25 V		<u> </u>	1.2		
neverse recovery charge	Q <sub>rr</sub>	al:/al+		-	1.2	2.4	μC

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 



# SiHD5N80AE

**Vishay Siliconix** 

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

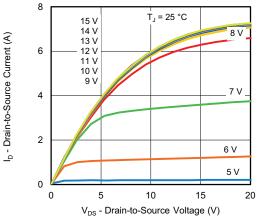


Fig. 1 - Typical Output Characteristics

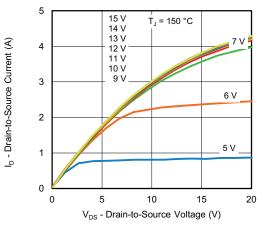


Fig. 2 - Typical Output Characteristics

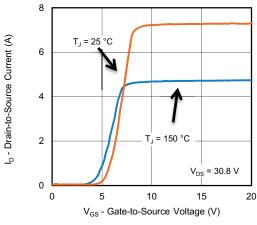


Fig. 3 - Typical Transfer Characteristics

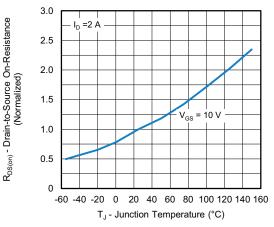


Fig. 4 - Normalized On-Resistance vs. Temperature

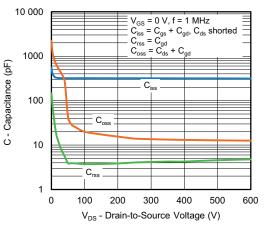
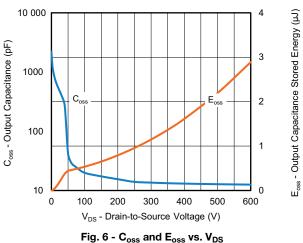


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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SiHD5N80AE

**Vishay Siliconix** 

5

4

3

2

1

0

V<sub>DS</sub> - Drain-to-Source Breakdown Voltage (Normalized)

25

1.2

1.1

1

0.9

0.8

-60 -40

-20 0

50

75

T<sub>C</sub> - Case Temperature (°C)

Fig. 10 - Maximum Drain Current vs. Case Temperature

100

125

I<sub>D</sub> = 250uA

20 40 60 80 100 120 140 160

T<sub>J</sub> - Junction Temperature (°C)

Fig. 11 - Normalized Breakdown Voltage vs. Temperature

150

l<sub>D</sub> - Drain Current (A)

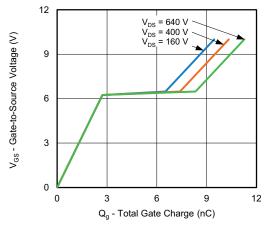


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

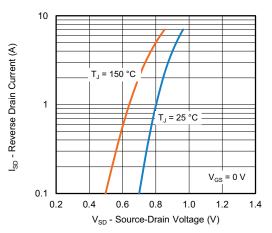


Fig. 8 - Typical Source-Drain Diode Forward Voltage

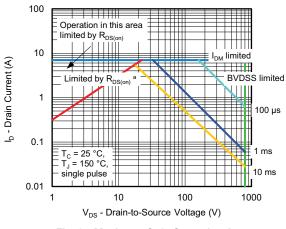


Fig. 9 - Maximum Safe Operating Area

Note

Downloaded from Arrow.com.

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

4



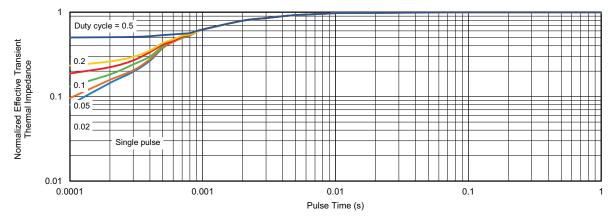


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

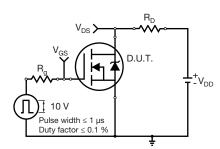


Fig. 13 - Switching Time Test Circuit

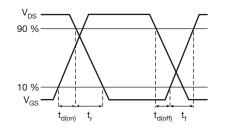


Fig. 14 - Switching Time Waveforms

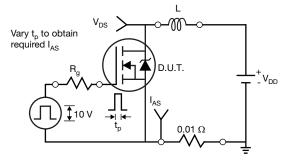
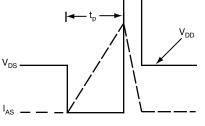


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

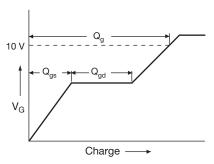


Fig. 17 - Basic Gate Charge Waveform

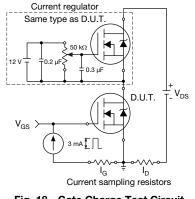


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dv/dt Test Circuit

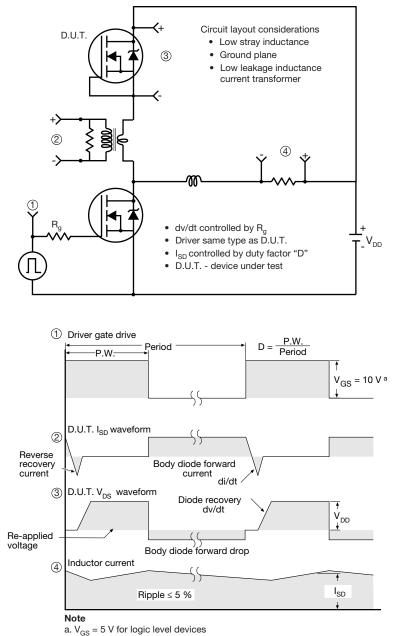


Fig. 19 - For N-Channel

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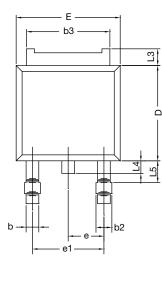
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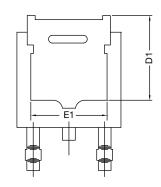


## **TO-252AA Case Outline**

### VERSION 1: FACILITY CODE = Y







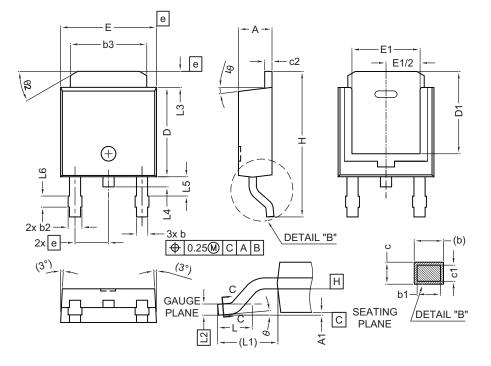
	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

#### Note

Dimension L3 is for reference only



### VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
с	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
e	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	1 ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

#### Notes

Dimensioning and tolerance confirm to ASME Y14.5M-1994

All dimensions are in millimeters. Angles are in degrees

Heat sink side flash is max. 0.8 mm

Radius on terminal is optional ٠

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347

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## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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